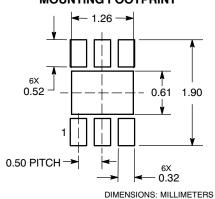


SOLDERMASK DEFINED MOUNTING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

UDFN6 1.6x1.6, 0.5P

DATE 26 OCT 2007

NOTES:

- DIMENSIONING AND TOLERANCING PER ASME Y14.5M. 1994.
- ASME Y14.5M, 1994.
 CONTROLLING DIMENSION: MILLIMETERS.
 DIMENSION & APPLIES TO PLATED TERMINAL
 AND IS MEASURED BETWEEN 0.15 AND
 0.30 mm FROM TERMINAL.
 COPLANARITY APPLIES TO THE EXPOSED
 PAD AS WELL AS THE TERMINALS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.45	0.55	
A1	0.00	0.05	
А3	0.13 REF		
b	0.20	0.30	
D	1.60 BSC		
Е	1.60 BSC		
e	0.50 BSC		
D2	1.10	1.30	
E2	0.45	0.65	
K	0.20		
L	0.20	0.40	
L1	0.00	0.15	

GENERIC MARKING DIAGRAM*



XX = Specific Device Code

M = Date Code

■ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

DESCRIPTION:	6 PIN UDFN, 1.6X1.6, 0.5P		PAGE 1 OF 2
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